



Product Change Notification

Change Notification #:

116746 - 00

Change Title:

**Select Intel® SSD DC P4511 Series Products,
PCN 116746-00, Product Design,
Firmware and FETs updates**

Date of Publication:

March 1, 2019

Key Characteristics of the Change:

Product Design

Forecasted Key Milestones:

Date Customer Must be Ready to Receive Post-Conversion Material:	May 6, 2019
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Description of Change to the Customer:

The Intel® SSD DC P4511 Series SKUs will undergo the following changes:

1. The firmware version is being updated from VCV10301 to VCV10352. The changes in the new firmware version are incremental improvements from previous version. Inventory will transition in the Intel factory on or beyond the above date to replace older firmware version with the latest version.
2. Update FET from (Onsemi FDG1024NZ to NXP SEMICONDUCTORS NX3008NBKS)
3. Update FET from (OnSemiconductor NTJD4152PT1G to NEXPERIA USA INC BSS84AKS)

Customer Impact of Change and Recommended Action:

Customers can expect to receive post conversion materials post the “Ready to Receive” date.

Milestone dates are estimates and subject to change based on business and operational conditions.

Products Affected / Intel Ordering Codes:

Marketing Name	Product Code	MM#	Pre Change TA	Pre Change SA	Pre Change PBA	Post Change TA	Post Change SA	Post Change PBA
Intel® SSD DC P4511 Series (1.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX010T801	965843	J96905-101	J96912-101	J74130-201	J96905-102	J96912-102	J74130-203
Intel® SSD DC P4511 Series (2.0TB, M.2 110mm PCIe 3.1 x4, 3D2, TLC) Generic Single Pack	SSDPELKX020T801	965844	J96906-101	J96913-101	J74131-201	J96906-102	J96913-102	J74131-203

PCN Revision History:

Date of Revision:

March 1, 2019

Revision Number:

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Reason:

Originally Published PCN



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Should you have any issues with the timeline or content of this change, please contact the Intel Representative(s) for your geographic location listed below. No response from customers will be deemed as acceptance of the change and the change will be implemented pursuant to the key milestones set forth in this attached PCN.

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